

# SiP4280A

Vishay Siliconix

# **Slew Rate Controlled Load Switch**

## FEATURES

- 1.5 V to 5.5 V Input Voltage range
- Very Low  $R_{DS(ON)}$ , typically 80 m $\Omega$  (5 V)
- Slew rate limited turn-on time options
  - SiP4280A-1: 1 ms
  - SiP4280A-3: 100 µs
- · Fast shutdown load discharge option
- Low quiescent current
- < 25 nA (typ)
- 4 kV ESD Rating
- 6 pin SOT23 package

## DESCRIPTION

The SiP4280A is a P-Channel MOSFET power switch designed for high-side load switching applications. The output pass transistor is a P-Channel MOSFET transistor with typically 80 m $\Omega$  R<sub>DS(ON)</sub>. The SiP4280A is available in two different versions of turn-on times. The SiP4280A-1 version has a slew rate limited turn-on time typically of 1 ms. The SiP4280A-3 version has a slew rate limited turn-on time typically of 1 ms and additionally offers a shutdown load discharge circuit to rapidly turn off a load circuit when the switch is disabled.

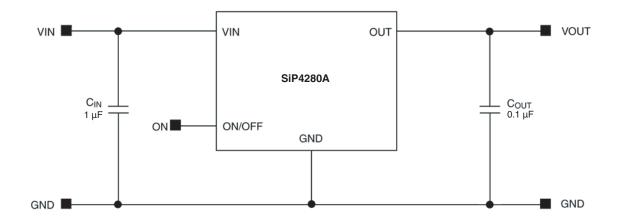
## APPLICATIONS

- Cellular telephones
- Digital still cameras
- Personal digital assistants (PDA)
- Hot swap supplies
- Notebook computers
- Personal communication devices



Both SiP4280A load switch versions operate with an input voltage ranging from 1.5 V to 5.5 V, making them ideal for both 3 V and 5 V applications. The SiP4280A also features an under-voltage lock out which turns the switch off when an input undervoltage condition exists. Input logic levels are TTL and 2.5 V to 5.0 V CMOS compatible. The quiescent supply current is very low, typically 25 nA. In shutdown mode, the supply current decreases to less than 1.0  $\mu$ A.

The SiP4280A is available in a 6 pin SOT23 package and is specified over - 40  $^\circ\text{C}$  to 85  $^\circ\text{C}$  temperature range.



## TYPICAL APPLICATION CIRCUIT

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## ABSOLUTE MAXIMUM BATINGS

Parameter		Symbol	Steady State	Unit		
Supply Input Voltage		V <sub>IN</sub>	- 0.3 to 6			
Enable Input Voltage		V <sub>ON</sub>	- 0.3 to 6	V		
Output Voltage		V <sub>OUT</sub>	- 0.3 to V <sub>IN</sub> + 0.3			
Maximum Switch Current		I <sub>MAX</sub>	2.3			
Maximum Pulsed Current	$V_{IN} \ge 2.5$	I <sub>DM</sub>	6	А		
	V <sub>IN</sub> < 2.5	I <sub>DM</sub>	3			
Junction Temperature		TJ	- 40 to 150	°C		
Thermal Resistance	SOT23-6L	$\Phi_{JA}^{a}$	180	°C/W		
Power Dissipation	SOT23-6L <sup>b</sup>	PD	440	mW		

Notes:

a. Device mounted with all leads soldered or welded to PC board. b. Derate 5.5 mW/°C above  $T_A = 70$  °C.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

<b>RECOMMENDED OPERATING RANGE</b> all voltages referenced to GND = 0 V					
Parameter	Unit				
	V <sub>IN</sub>	1.5 to 5.5	V		
Operating Temperature Range		- 40 to 85	°C		

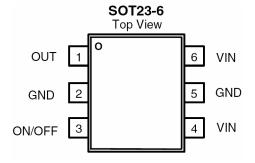
#### **SPECIFICATIONS** Limits **Test Conditions Unless Specified** $V_{IN}$ = 5 V, $T_A$ = - 40 to 85 $^\circ C$ Min<sup>a</sup> Typ<sup>b</sup> Max<sup>a</sup> Unit Parameter Symbol SiP4280A All Versions V **Operating Voltage** V<sub>IN</sub> 1.5 5.5 -ON/OFF = active Quiescent Current ΙQ 1 -Off Supply Current ON/OFF = inactive, OUT = open 0.01 I<sub>Q(OFF)</sub> -1 μΑ ON/OFF = inactive, V<sub>OUT</sub> = 0 Off Switch Current 0.01 1 I<sub>SD(OFF)</sub> \_ V<sub>IN</sub> = 5 V, T<sub>A</sub> = 25 °C 80 120 \_ V<sub>IN</sub> = 4.2 V, T<sub>A</sub> = 25 °C 85 130 -**On-Resistance** R<sub>DS(ON)</sub> mΩ V<sub>IN</sub> = 3 V, T<sub>A</sub> = 25 °C 100 150 -V<sub>IN</sub> = 1.8 V, T<sub>A</sub> = 25 °C 250 -160 TC<sub>RDS</sub> **On-Resistance Temp-Coefficient** -2800 ppm/°C VIL V<sub>IN</sub> = 1.8 V to 5.5 V ON/OFF Input Low Voltage<sup>c</sup> -0.4 V<sub>IN</sub> = 1.5 V to 2.7 V 1.4 ٧ $V_{IH}$ $V_{IN} = 2.7 \text{ V to} < 4.2 \text{ V}$ **ON/OFF** Input High Voltage 2 \_ \_ $V_{IN} \ge 4.2 \text{ V}$ to 5.5 V 2.4 V<sub>ON/OFF</sub> = 5.5 V **ON/OFF** Input Leakage μA I<sub>SINK</sub> 1 --SiP4280A-1 Version $V_{IN} = 5 \text{ V}, \text{ R}_{LOAD} = 10 \Omega, \text{ T}_{A} = 25 \text{ }^{\circ}\text{C}$ Output Turn-On Delay Time 20 40 T<sub>D(ON)</sub> -Output Turn-On Rise Time V<sub>IN</sub> = 5 V, R<sub>LOAD</sub> = 10 Ω, T<sub>A</sub> = 25 °C T<sub>ON</sub> -1000 1500 us Output Turn-Off Delay Time V<sub>IN</sub> = 5 V, R<sub>LOAD</sub> = 10 Ω, T<sub>A</sub> = 25 °C 4 T<sub>D(OFF)</sub> 10 -SiP4280A-3 Version $V_{IN} = 5 \text{ V}, \text{ R}_{LOAD} = 10 \Omega, \text{ T}_{A} = 25 \text{ }^{\circ}\text{C}$ Output Turn-On Delay Time T<sub>D(ON)</sub> 20 40 -Output Turn-On Rise Time $V_{IN} = 5 \text{ V}, \text{ R}_{LOAD} = 10 \Omega, \text{ T}_{A} = 25 \text{ }^{\circ}\text{C}$ 100 150 TON μs $V_{IN} = 5 \text{ V}, \text{ R}_{LOAD} = 10 \Omega, \text{ T}_{A} = 25 \text{ }^{\circ}\text{C}$ Output Turn-Off Delay Time T<sub>D(OFF)</sub> -4 10 $ON/OFF = inactive, T_A = 25 \ ^{\circ}C$ R<sub>PD</sub> **Output Pull-Down Resistance** -150 250 Ω

Notes:

a. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum. b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing. d. For  $V_{IN} \le 1.5$  V see typical ON/OFF threshold curve.



## **PIN CONFIGURATION**



PIN DESCRIPTION				
Pin Number SOT23-6	Pin Name	Description		
4, 6	V <sub>IN</sub>	This pin is the P-Channel MOSFET source connection		
3	ON/OFF	Logic high enables the IC; logic low disables the IC		
2, 5	GND	Ground connection		
1	OUT	This pin is the P-Channel MOSFET drain connection		

## SELECTION GUIDE

Part Number	Part Number (typ)		Enable	
SiP4280A-1-T1-E3	1 ms	No	Active High	
SiP4280A-3-T1-E3	100 µs	Yes	Active High	

ORDERING INFORMATION						
Part Number Marking		Temperature Range	Package			
SiP4280ADT-1-T1-E3	L4XX	- 40 °C to 85 °C	SOT23-6L			
SiP4280ADT-3-T1-E3	L6XX	- 40 0 10 85 0	SOT23-6L			

5.0

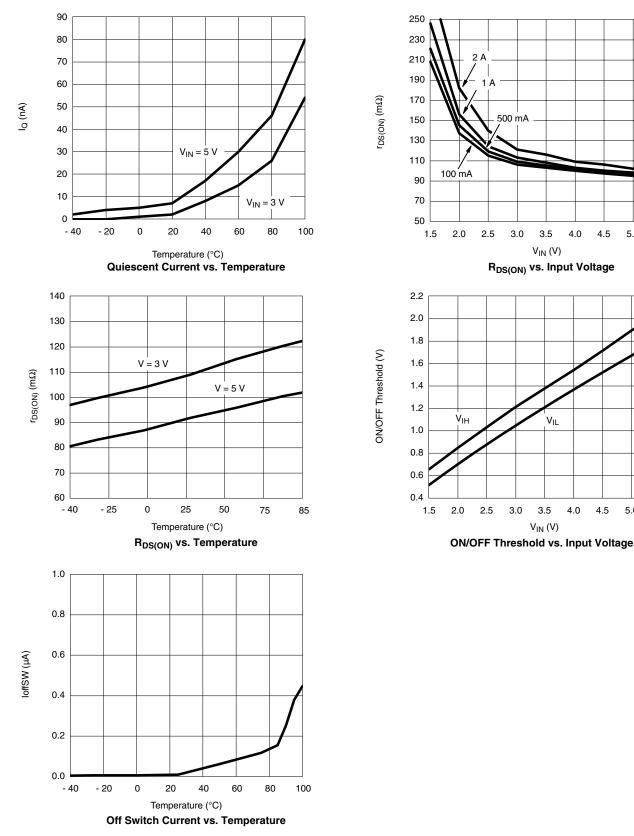
5.0

5.5

5.5

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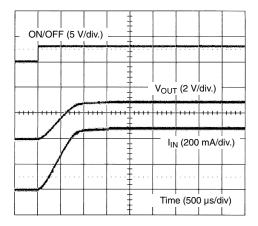
## TYPICAL CHARACTERISTICS internally regulated, 25 °C unless noted



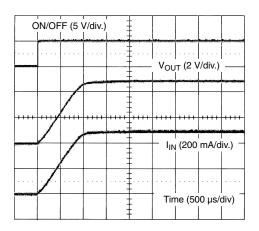




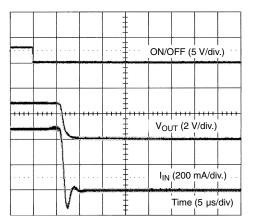
## **TYPICAL WAVEFORMS**



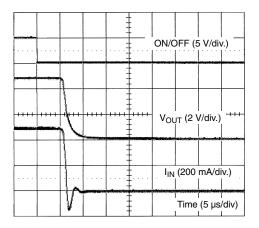
SiP4280A-1 Turn-On (V<sub>IN</sub> = 3 V,  $R_{LOAD}$  = 6  $\Omega$ )



SiP4280A-1 Turn-On (V<sub>IN</sub> = 5 V, R<sub>LOAD</sub> = 10  $\Omega$ )



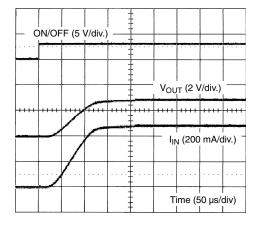
SiP4280A-1 Turn-Off (V<sub>IN</sub> = 3 V, R<sub>LOAD</sub> = 6  $\Omega$ )



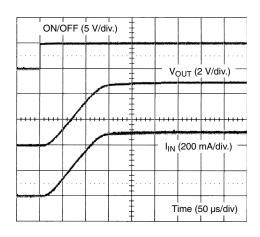
SiP4280A-1 Turn-Off (V<sub>IN</sub> = 5 V, R<sub>LOAD</sub> = 10  $\Omega$ )

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SiP4280A-3 Turn-On (V<sub>IN</sub> = 3 V, R<sub>LOAD</sub> = 6  $\Omega$ )

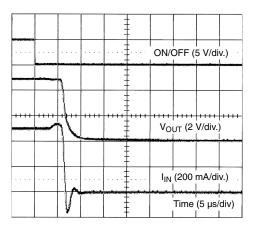


SiP4280A-3 Turn-On (V<sub>IN</sub> = 5 V, R<sub>LOAD</sub> = 10  $\Omega$ )



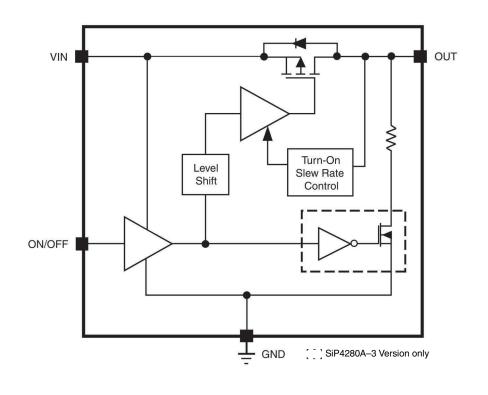
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 		+++++		-	V <sub>OI</sub>	די (2 V/div.) די			
			-	-					
 				- - · · · · ·	I <sub>IN</sub>	(200	mA/di	v.)	
	$\mathbf{V}$			-	ant at a search	Time	(5 µs/	/div)	

SiP4280A-3 Turn-Off (V<sub>IN</sub> = 3 V, R<sub>LOAD</sub> = 6  $\Omega$ )



SiP4280A-3 Turn-Off (V<sub>IN</sub> = 5 V, R<sub>LOAD</sub> = 10  $\Omega$ )







#### **DETAILED DESCRIPTION**

The SiP4280A is a P-Channel MOSFET power switches designed for high-side slew rate controlled load switching applications. Once turned on, the slew-rate control circuitry is activated and current is ramped in a linear fashion until it reaches the level required for the output load condition. This is accomplished by first elevating the gate voltage of the MOSFET up to its threshold voltage and then by linearly increasing the gate voltage until the MOSFET becomes fully enhanced. At this point, the gate voltage to reduce  $R_{DS(ON)}$  of the MOSFET switch and minimize any associated power losses.

The SiP4280A-1 version has a modest 1 ms turn on slew rate feature, which significantly reduces in-rush current at turned on time and permits the load switch to be implemented with a small input capacitor, or no input capacitor at all, saving cost and space. In addition to a 100  $\mu$ s minimized slew rate, the SIP4280A-3 features a shutdown output discharge circuit which is activated at shutdown (when the part is disabled through the ON/OFF pin) and discharges the output pin through a small internal resistor hence, turning off the load.

In instances where the input voltage falls below 1.4 V (typically) the under voltage lock-out circuitry protects the MOSFET switch from entering the saturation region or operation by shutting down the chip.

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## **APPLICATION INFORMATION**

#### **Input Capacitor**

While a bypass capacitor on the input is not required, a 1  $\mu$ F or larger capacitor for C<sub>IN</sub> is recommended in almost all applications. The Bypass capacitor should be placed as physically close as possible to the SiP4280A to be effective in minimizing transients on the input. Ceramic capacitors are recommended over tantalum because of their ability to withstand input current surges from low impedance sources such as batteries in portable devices.

## **Output Capacitor**

A 0.1  $\mu$ F capacitor or larger across V<sub>OUT</sub> and GND is recommended to insure proper slew operation. C<sub>OUT</sub> may be increased without limit to accommodate any load transient condition with only minimal affect on the SiP4280A turn on slew rate time. There are no ESR or capacitor type requirement.

## Enable

The ON/OFF pin is compatible with both TTL and CMOS logic voltage levels.

## **Reverse Voltage Conditions and Protection**

The P-Channel MOSFET pass transistor has an intrinsic diode that is reversed biased when the input voltage is greater than the output voltage. Should  $V_{OUT}$ exceed  $V_{IN}$ , this intrinsic diode will become forward biased and allow excessive current to flow into the IC thru the  $V_{OUT}$  pin and potentially damage the IC device. Therefore extreme care should be taken to prevent  $V_{OUT}$  from exceeding  $V_{IN}$ .

In conditions where  $V_{OUT}$  exceeds  $V_{IN}$  a Schottky diode in parallel with the internal intrinsic diode is recommended to protect the SiP4280A.

## **Thermal Considerations**

The SiP4280A is designed to maintain a constant output load current. The internal switch is designed to operate at 2.3 A of current, as stated in the ABS MAX



table. However, The real limiting factor for the safe operating load current is the thermal power dissipation of the package. To obtain the highest power dissipation the power pad of the device should be connected to a heat sink on the printed circuit board.

The maximum power dissipation in any application is dependant on the maximum junction temperature,  $T_{J(MAX)} = 125$  °C, the junction-to-ambient thermal resistance  $\theta_{J-A} = 180$  °C for SOT23-6, and the ambient temperature,  $T_A$ , which may be formulaically expressed as:

P (max) = 
$$\frac{T_{J} (max) - T_{A}}{\theta_{J-A}} = \frac{125 - T_{A}}{140}$$

It then follows that, assuming an ambient temperature of 70 °C, the maximum power dissipation will be limited to about 305 mW for SOT23-6.

In any application, the maximum continuous switch current is a function two things: the package power dissipation and the  $R_{DS(ON)}$  at the ambient temperature. As an example let us calculate the worst-case maximum load current at  $T_A$ = 70 °C. The worst case  $R_{DS(ON)}$  at 25 °C occurs at an input voltage of 1.8 V and is equal to 250 m $\Omega$ . The  $R_{DS(ON)}$  at 70 °C can be extrapolated from this data using the following formula

 $R_{DS(ON)}$  (at 70 °C) =  $R_{DS(ON)}$  (at 25 °C) x (1 +  $T_C x \Delta T$ )

Where  ${\rm T}_{\rm C}$  is 2090 ppm/°C. Continuing with the calculation we have

$$R_{DS(ON)}$$
 (at 70 °C) = 250 mΩ x (1 + 0.00209 x (70 °C - 25 °C)) = 278 mΩ

The maximum current limit is then determined by

$$I_{LOAD}$$
 (max)  $\langle \sqrt{\frac{P(max)}{R_{DS(ON)}}} \rangle$ 

which in case is 1.05 A for SOT23-6. Under the stated input voltage condition, if the calculated current limit is exceeded the internal die temperature will rise and eventually, possibly damage the device.

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